



Product/Process Change Notice - PCN 22_0214 Rev. -

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This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title: HMC8411 Data Sheet Revision

Publication Date: 07-Sep-2022

Effectivity Date: 10-Dec-2022 *(the earliest date that a customer could expect to receive changed material)*

Revision Description:

Initial Release.

Description Of Change:

Changing thermal resistance Value from 82 to 115.35 C/W.

Reason For Change:

Correcting junction to case resistance value on data sheet.

Impact of the change (positive or negative) on fit, form, function & reliability:

No change to fit, form, function, or reliability.

Summary of Supporting Information:

Changes will be reflected Product Data Sheet REV.C.

Supporting Documents

Attachment 1: Type: Revised Datasheet Specification

ADI_PCN_22_0214_Rev_-_HMC8411 Data Sheet Revision.pdf

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:
PCN_Americas@analog.com

Europe:
PCN_Europe@analog.com

Japan:
PCN_Japan@analog.com

Rest of Asia:
PCN_ROA@analog.com

Appendix A - Affected ADI Models				
Added Parts On This Revision - Product Family / Model Number (4)				
HMC8411 / HMC8411LP2FE	HMC8411 / HMC8411LP2FETR	HMC8411 / HMC8411TCPZ-EP-PT	HMC8411 / HMC8411TCPZ-EP-R7	

Appendix B - Revision History			
Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	07-Sep-2022	10-Dec-2022	Initial Release.

HMC8411LP2FE Data Sheet Revision – Thermal Resistance Change

HMC8411LP2FE Thermal Resistance Change

HMC8411LP2FE - Thermal Resistance Change	
θ_{JC} Original ($^{\circ}\text{C}/\text{W}$)	θ_{JC} Updated ($^{\circ}\text{C}/\text{W}$)
82	115.35